

AS-Master

Applications : RTA, RTO, RTCVD, Reflow, Implantation annealing...
Substrate size : up to 8-inch diameter
Temperature max. : 1450°C (depending on version)
Temperature ramp rate : 200°C/s on 8-inch silicon wafer (depending on version)
Temperature control : multi-zone, thermocouple or pyrometer, fast PID
Vacuum capability : 10⁻³ Torr (10⁻⁶ Torr option)
Gas lines : up to 6 gas lines with MFC and one purge line with needle valve
Loading : manual, optional cassette to cassette
Product link: <http://www.annealsys.com/annealsys-products/rtp-rtcvd/as-master.html>

- (1) ***“Product links” always point to the product and are not subject to change even if there is some modification in the description of the product. This link can be used reliably over time***